

MOSFET

Metal Oxide Semiconductor Field Effect Transistor

OptiMOS[™]

OptiMOS[™]5 Power-MOSFET, 25 V BSZ014NE2LS5IF

Data Sheet

Rev. 2.1 Final

Power Management & Multimarket





BSZ014NE2LS5IF

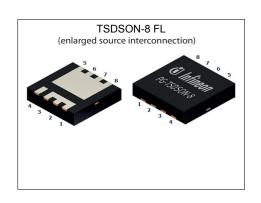
1 Description

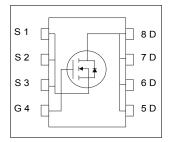
Features

- Optimized for synchronous rectification
- Monolithic integrated Schottky like diode
- Very low on-resistance R_{DS(on)} @ V_{GS}=4.5 V
- Excellent gate charge x R_{DS(on)} product (FOM)
- 100% avalanche tested
- N-channel
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21



Parameter	Value	Unit					
V _{DS}	25	V					
R _{DS(on),max}	1.45	mΩ					
I _D	40	A					
Qoss	26	nC					
Q _G (0V4.5V)	11	nC					











Type / Ordering Code	Package	Marking	Related Links
BSZ014NE2LS5IF	PG-TSDSON-8 FL	14NE2L5	-

Final Data Sheet



OptiMOS[™]5 Power-MOSFET, 25 V

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2 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

D	Symbol	Values				
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current	ID	- - - -	- - - -	40 40 40 40 31	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W ¹⁾
Pulsed drain current ²⁾	I _{D,pulse}	-	-	160	Α	<i>T</i> _C =25 °C
Avalanche current, single pulse ³⁾	I _{AS}	-	-	20	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse	E _{AS}	-	-	80	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-16	-	16	V	-
Power dissipation	P _{tot}	-	69 2.1	-	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W ¹⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

3 Thermal characteristics

Table 3 **Thermal characteristics**

Doromotor	Symbol	Values			l lmi4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	1.8	K/W	-
Device on PCB, 6 cm ² cooling area ¹⁾	R _{thJA}	-	-	60	K/W	-

¹⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

2) >See figure 3 for more detailed information

3) See figure 13 for more detailed information



4 Electrical characteristics

Table 4 Static characteristics

Parameter	O. was book	Values			11!4	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	$V_{(BR)DSS}$	25	-	-	V	V _{GS} =0 V, I _D =10 mA
Breakdown voltage temperature coefficient	$dV_{(BR)DSS}/dT_{j}$	-	15	-	mV/K	I_D =10 mA, referenced to 25 °C
Gate threshold voltage	$V_{\mathrm{GS(th)}}$	1	-	2	V	V _{DS} =V _{GS} , I _D =250 μA
Zero gate voltage drain current	I _{DSS}	-	- 1	0.5	mA	V _{DS} =20 V, V _{GS} =0 V, T _j =25 °C V _{DS} =20 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	1.6 1.25	2.1 1.45	mΩ	V _{GS} =4.5 V, I _D =20 A V _{GS} =10 V, I _D =20 A
Gate resistance	R _G	-	0.8	1.3	Ω	-
Transconductance	g fs	70	140	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 20 \text{ A}$

Table 5 Dynamic characteristics

Developed	Or made at	Values			11		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	Ciss	-	1600	2300	pF	V _{GS} =0 V, V _{DS} =12 V, <i>f</i> =1 MHz	
Output capacitance ¹⁾	Coss	-	1400	1900	pF	V _{GS} =0 V, V _{DS} =12 V, <i>f</i> =1 MHz	
Reverse transfer capacitance	C _{rss}	-	70	-	pF	V _{GS} =0 V, V _{DS} =12 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	5	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	3	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	19	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	2	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω	

¹⁾ Defined by design. Not subject to production test.



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Table 6 Gate charge characteristics¹⁾

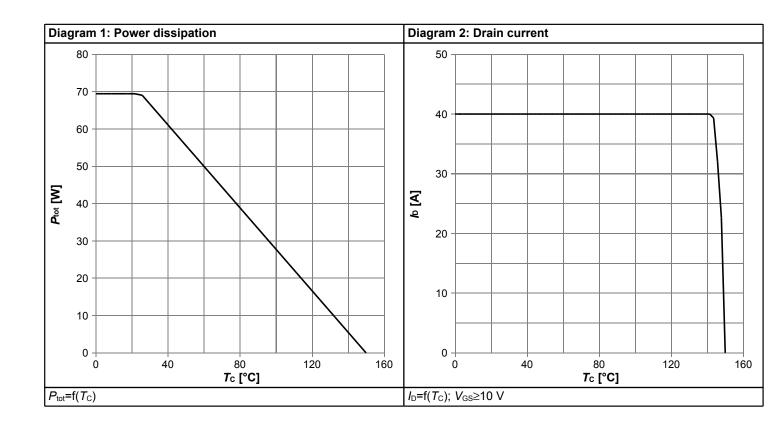
Parameter	Cumbal		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q gs	-	3.7	-	nC	V_{DD} =12 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	2.5	-	nC	V_{DD} =12 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate to drain charge	Q _{gd}	-	2.5	-	nC	V_{DD} =12 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	3.8	-	nC	V_{DD} =12 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total	Q g	-	11	16	nC	V_{DD} =12 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.4	-	V	V_{DD} =12 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total	Q g	-	23	33	nC	$V_{\rm DD}$ =12 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	9.4	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 4.5 V
Output charge	Q _{oss}	-	26	-	nC	V _{DD} =12 V, V _{GS} =0 V

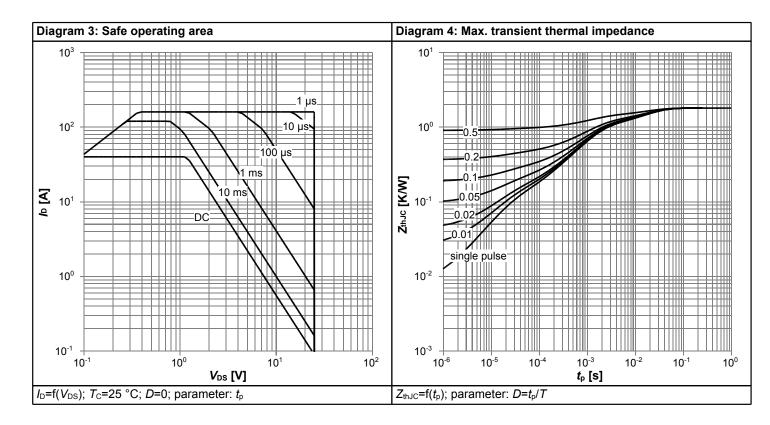
Table 7 Reverse diode

Parameter	Cumbal	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Ollit	Note / Test Condition
Diode continuous forward current	Is	-	-	40	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	160	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.48	0.6	V	V _{GS} =0 V, I _F =11 A, T _j =25 °C
Reverse recovery charge	Qrr	-	5	-	nC	V _R =15 V, I _F =11 A, di _F /dt=400 A/μs



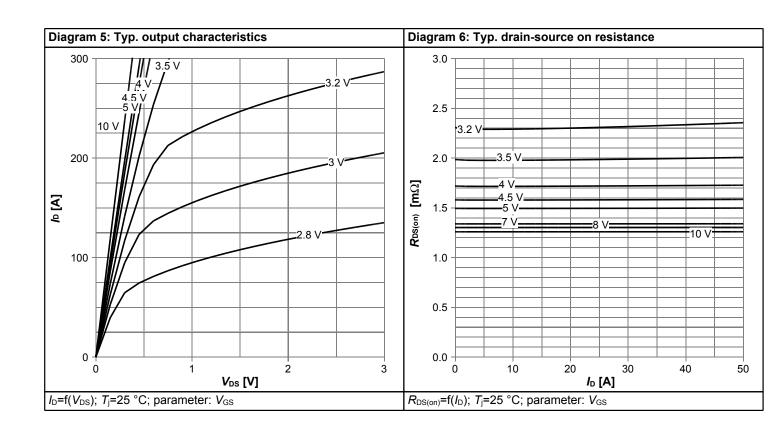
5 Electrical characteristics diagrams

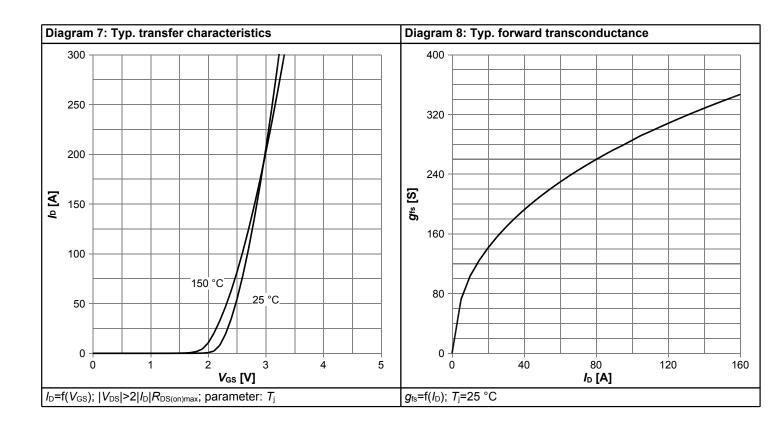




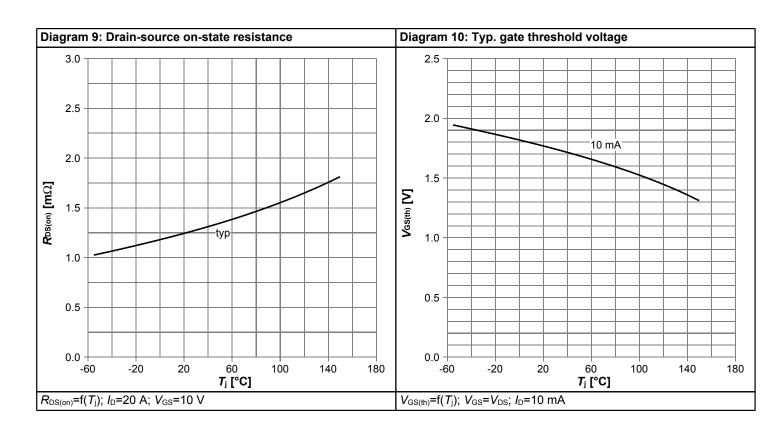


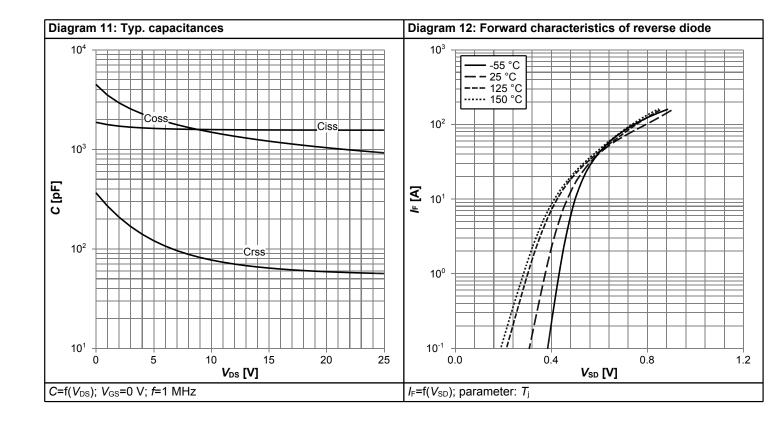
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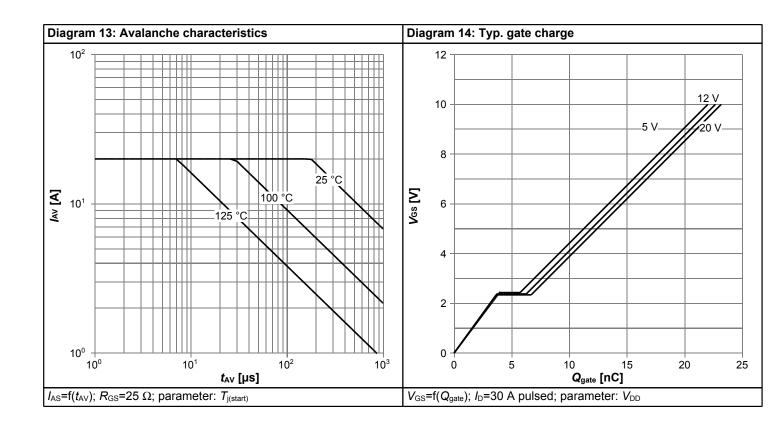


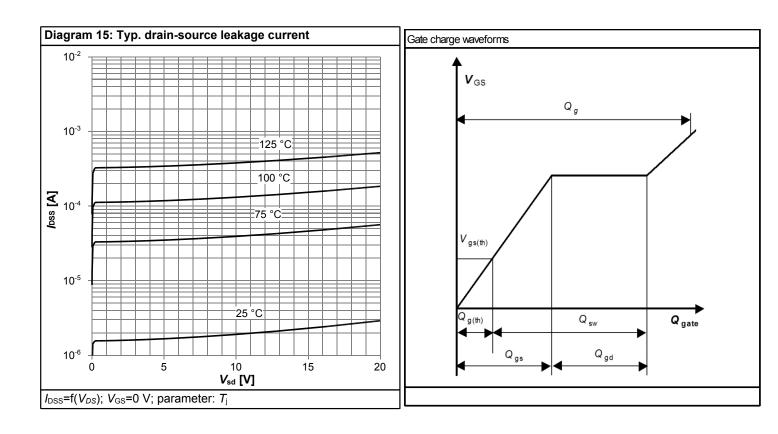














6 Package Outlines

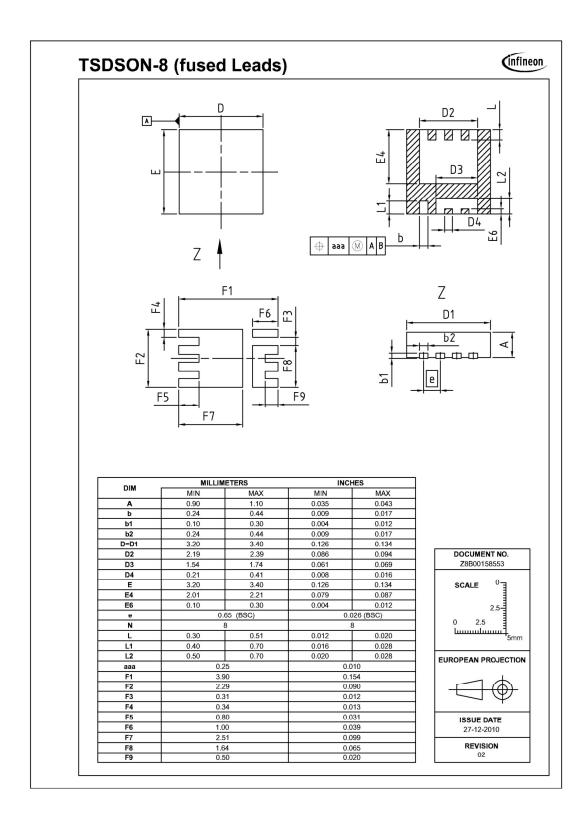


Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm/inches



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Revision History

BSZ014NE2LS5IF

Revision: 2015-04-27, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.1	2015-04-27	Rev. 2.0

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